KM2520F3C03

Infrared Emitting Diode



DESCRIPTION

 F3 Made with Gallium Arsenide Infrared Emitting diodes

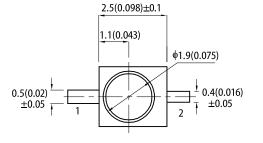
FEATURES

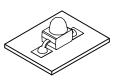
- Subminiature package
- · Mechanically and spectrally matched to the phototransistor
- · Gull wing lead
- Long life solid state reliability
- · Low package profile
- Moisture sensitivity level: 3
- Package: 1000 pcs / reel
- Halogen-free
- RoHS compliant

APPLICATIONS

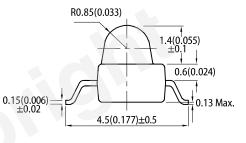
- · Infrared Illumination for cameras
- Machine vision systems
- Surveillance systems
- · Industrial electronics
- · IR data transmission
- Remote control

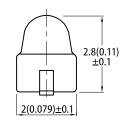
PACKAGE DIMENSIONS





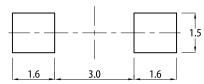






RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



Notes.

1. All dimensions are in millimeters (inches)

Tolerance is ±0.25(0.01") unless otherwise noted. The specifications, characteristics and technical data described in the datasheet are subject to change

without prior notice. 4. The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Po (mW/sr) @ 20mA [2]		Po (mW/sr) @ 50mA ^[2]		Viewing Angle ^[1]
			Min.	Тур.	Min.	Тур.	201/2
KM2520F3C03	Infrared (GaAs)	Water Clear	5	10	10	20	20°
			*3	*8	*8	*16	20

Notes

Notes: 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Radiant Intensity / luminous flux: +/-15%. * Radiant intensity value is traceable to CIE127-2007 standards.

ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symphol	Emitting Color	Value		Unit
Parameter	Symbol	Emitting Color Typ. Max.			
Wavelength at Peak Emission I_F = 20mA	λ_{peak}	Infrared	940	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	Infrared	50	-	nm
Capacitance	С	Infrared	90	-	pF
Forward Voltage I _F = 20mA	V _F ^[1]	Infrared	1.2	1.6	V
Reverse Current (V _R = 5V)	I _R	Infrared	-	10	μA
Temperature Coefficient of Wavelength I_F = 20mA, -10°C $\leq T \leq 85^\circ C$	TC _λ	Infrared	0.3	-	nm/°C
Temperature Coefficient of V_F I_F = 20mA, -10°C $\leq T \leq 85^\circ C$	TCv	Infrared	-1.2	-	mV/°C

Notes:

Forward voltage: ±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

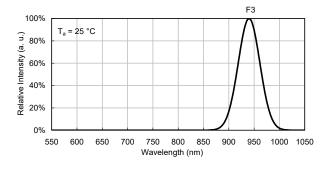
Parameter	Symbol	Value	Unit
Power Dissipation	PD	90	mW
Reverse Voltage	V _R	5	V
Junction Temperature	Tj	115	°C
Operating Temperature	T _{op}	-40 to +85	°C
Storage Temperature	T _{stg}	-40 to +85	°C
DC Forward Current	l _F	50	mA
Peak Forward Current	I _{FP} ^[1]	1200	mA
Electrostatic Discharge Threshold (HBM)	-	8000	V
Thermal Resistance (Junction / Ambient)	$R_{th \; JA}^{[2]}$	390	°C/W
Thermal Resistance (Junction / Solder point)	$R_{th}_{JS}^{[2]}$	230	°C/W

ABSOLUTE MAXIMUM RATINGS at $T_A=25^{\circ}C$

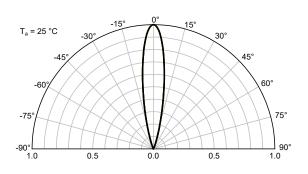
Notes: 1. 1/100 Duty Cycle, 10µs Pulse Width. 2. R_{In. J.A}, R_{In. J.S} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad). 3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

TECHNICAL DATA

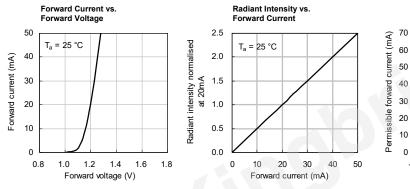
RELATIVE INTENSITY vs. WAVELENGTH



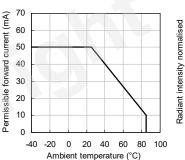
SPATIAL DISTRIBUTION



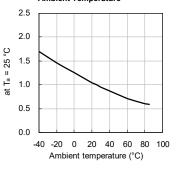
INFRARED



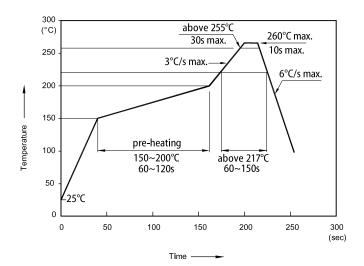
Forward Current Derating Curve



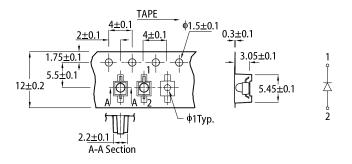
Radiant Intensity vs. Ambient Temperature



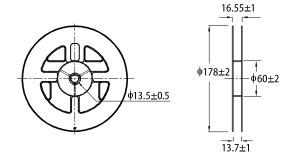
REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



TAPE SPECIFICATIONS (units : mm)



REEL DIMENSION (units : mm)



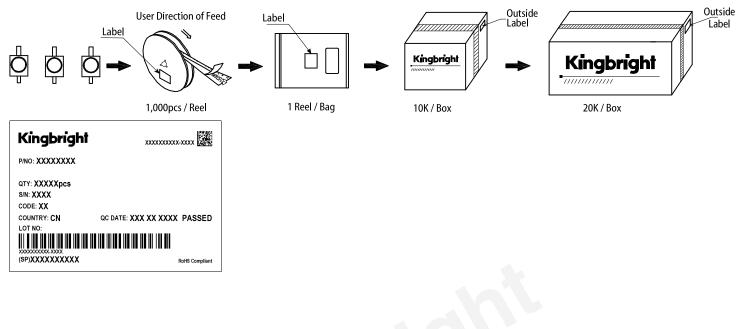
Notes

- Don't cause stress to the LEDs while it is exposed to high temperature.
 The maximum number of reflow soldering passes is 2 times.
 Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

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PACKING & LABEL SPECIFICATIONS



PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- 2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If
- 3.
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